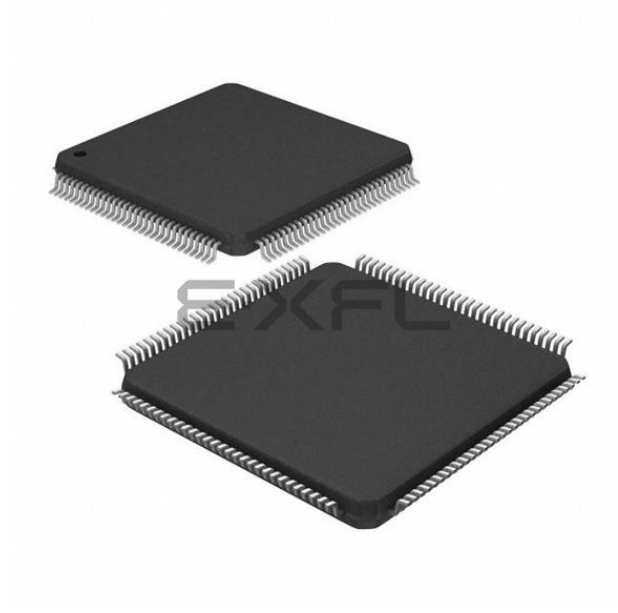
Infineon Technologies - MB90922NCSPMC-GS-112E1 Datasheet



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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	32MHz
Connectivity	CANbus, LINbus, UART/USART
Peripherals	LCD, LVD, POR, PWM, WDT
Number of I/O	93
Program Memory Size	256KB (256K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	120-LQFP
Supplier Device Package	120-LQFP (16x16)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90922ncspmc-gs-112e1

■ PRODUCT LINEUP

Part number / Parameter	MB90 F922NC	MB90 F922NCS	MB90 F923NC	MB90 F923NCS	MB90 F924NC	MB90 F924NCS	MB90 922NCS	MB90 V920-101	MB90 V920-102
Type	Flash memory product						MASK ROM product	Evaluation product	
CPU	F^2MC-16LX CPU								
System clock	PLL clock multiplier circuit (× 1, × 2, × 3, × 4, × 8, 1/2 when PLL stopped) Minimum instruction execution time 31.25 ns (with 4 MHz oscillation clock × 8)								
Sub clock pins (X0A, X1A)	Yes	No	Yes	No	Yes	No	No	No	Yes
ROM	Flash memory 256 Kbytes		Flash memory 384 Kbytes		Flash memory 512 Kbytes		256 K bytes	External	
RAM	10 Kbytes		16 Kbytes		24 Kbytes		10 K bytes	30 Kbytes	
I/O port	91 ports	93 ports	91 ports	93 ports	91 ports	93 ports	93 ports	93 ports	91 ports
LCD controller	32 segment × 4 common								
LIN-UART	UART (LIN/SCI) 4 channels								
CAN interface	4 channels								
16-bit input capture	8 channels								
16-bit reload timer	4 channels								
16-bit free-run timer	1 channel								
Real time watch timer	1 channel								
16-bit PPG timer	6 channels								
External interrupt	8 channels								
8/10-bit A/D converter	8 channels								
Low-voltage/ CPU operating detection reset	Yes							No	
Stepping motor controller	4 channels								
Sound generator	2 channels								
Flash memory security	Yes						—		
Operating voltage	4.0 V to 5.5 V							4.5 V to 5.5 V	
Package	LQFP-120							PGA-299	

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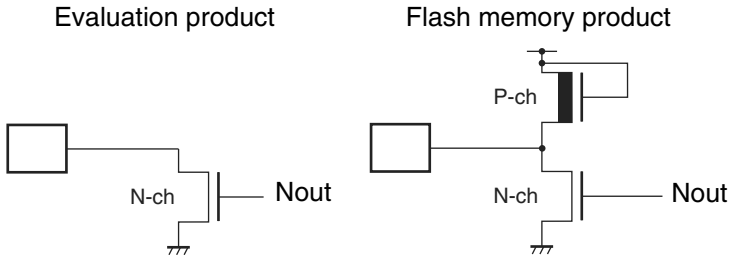
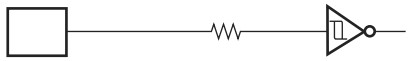
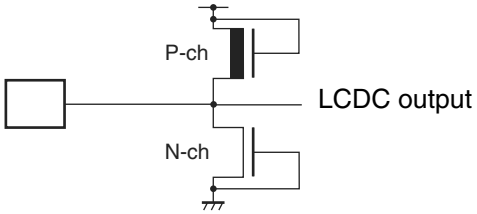
Type	Circuit	Remarks
N		N-ch open-drain pin I_{OL} = 4 mA
O		Input-only pin Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})
P		LCDC output pin (COM pin)

■ HANDLING DEVICES

• Strictly observe maximum rated voltages (preventing latch-up)

In CMOS IC devices, a condition known as latch-up may occur if voltages higher than V_{CC} or lower than V_{SS} are applied to input or output pins other than medium or high withstand voltage pins, or if the voltage applied between VCC and VSS pins exceeds the rated voltage level. If a latch-up occurs, the power supply current may increase dramatically and may destroy semiconductor elements. When using semiconductor devices, always take sufficient care to avoid exceeding maximum ratings.

When the analog system power supply is switched on or off, be careful not to apply the analog power supply (AV_{CC}, AVRH), the analog input voltages and the power supply voltage for the high current output buffer pins (DV_{CC}) in excess of the digital power supply voltage (V_{CC}).

Once the digital power supply voltage (V_{CC}) has been disconnected, the analog power supply (AV_{CC}, AVRH) and the power supply voltage for the high current output buffer pins (DV_{CC}) may be turned on in any sequence.

• Supply voltage stabilization

Rapid fluctuations in the power supply voltage can cause malfunctions even if the Vcc power supply voltage remains within the warranted operating range. It is recommended that the power supply be stabilized such that ripple fluctuations (P-P value) at commercial frequencies (50 Hz/60 Hz) be limited to within 10% of the standard V_{CC} value, and that transient fluctuations due to power supply switching, etc. be limited to a rate of 0.1 V/ms or less.

• Precautions when turning the power on

In order to prevent the built-in step-down circuits from malfunctioning, the time taken for the voltage to rise (0.2 V to 2.7 V) during power-on should be less than 50 μs.

• Handling unused pins

If unused input pins are left open, they may cause malfunctions or latch-up which may lead to permanent damage to the semiconductor. Unused input pins should therefore be pulled up or pulled down through a resistor of at least 2 kΩ.

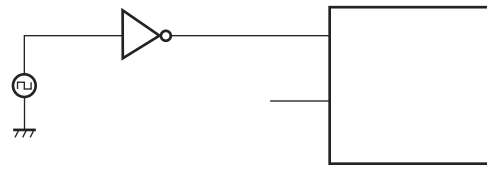
Unused input/output pins may be set to the output state and left open, or set to the input state and connected to a pull-up or pull-down resistance of 2 kΩ or more.

• Handling A/D converter power supply pins

Even if the A/D converter is not used, the power supply pins should be connected such as $AV_{CC} = V_{CC}$, and $AV_{SS} = AVRH = V_{SS}$.

• Notes on using an external clock

Even when an external clock is used, an oscillation stabilization wait time is required following power-on reset or release from sub clock mode or stop mode. Furthermore, only the X0A pin should be driven when an external clock is used, with the X1A pin open as shown in the following diagram. Do not use high-speed oscillation pins (X0 and X1) for external clock input.



Sample external clock connection

- **Handling the power supply for high-current output buffer pins** (DV_{CC}, DV_{SS})

  - **Flash memory products and MASK ROM products (MB90F922NC/F922NCS/922NCS/F923NC/ F923NCS/F924NC/F924NCS)**

    In the Flash memory products and MASK ROM products, the power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) is isolated from the digital power supply (V_{CC}).
    Therefore, DVcc can therefore be set to a higher voltage than Vcc. If the power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) is supplied before the digital power supply (V_{CC}), however, care needs to be taken because it is possible that the port 7 or port 8 stepping motor outputs may momentarily output an “H” or “L” level. In order to prevent this, connect the digital power supply (V_{CC}) prior to connecting the power supply for the high-current output buffer pins. Even when the high-current output buffer pins are used as general-purpose ports, power should be supplied to the power supply pins for the high-current output buffer pins (DV_{CC}, DV_{SS}).

  - **Evaluation product** (**MB90V920-101**/**MB90V920-102**)

    In the evaluation products, the power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) is not isolated from the digital power supply (V_{CC}). Therefore, DV_{CC} must therefore be set to a lower voltage than Vcc. The power supply for the high-current output buffer pins (DV_{CC}, DV_{SS}) must always be applied after the digital power supply (V_{CC}) has been connected, and disconnected before the digital power supply (Vcc) is disconnected (the power supply for the high-current output buffer pins may also be connected and disconnected simultaneously with the digital power supply).
    Even when the high-current output buffer pins are used as general-purpose ports, power should be supplied to the power supply pins for the high-current output buffer pins (DV_{CC}, DV_{SS}).

- **Pull-up/pull-down resistors**

MB90920 series does not support internal pull-up/pull-down resistors. Use external components as necessary.

- **Precautions when not using a sub clock signal**

If the X0A and X1A pins are not connected to an oscillator, apply a pull-down resistance to the X0A pin and leave the X1A pin open.

- **Notes on operating when the external clock is stopped**

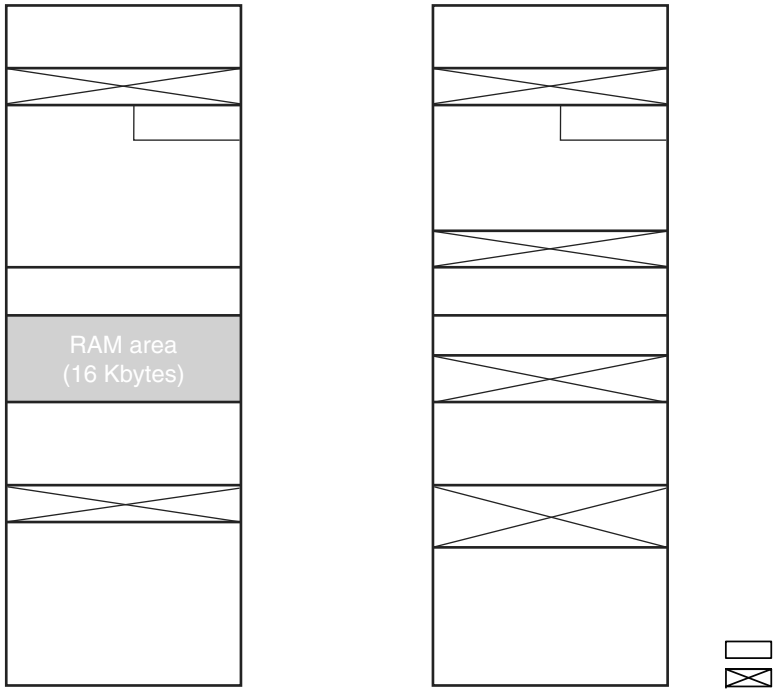
The MB90920 series is not guaranteed to operate correctly using the internal oscillator circuit when there is no external oscillator or the external clock input is stopped.

- **Flash memory security function**

A security bit is located within the Flash memory region. The security function is activated by writing the protection code 01_H to the security bit.
Do not write the value 01_H to this address if you are not using the security function.
Please refer to following table for the address of the security bit.

	Flash memory size	Address for security bit
MB90F922NC MB90F922NCS	Built-in 2 Mbits Flash Memory	$FC0001_H$
MB90F923NCS	Built-in 3 Mbits Flash Memory	$F80001_H$
MB90F924NCS	Built-in 4 Mbits Flash Memory	$F80001_H$

■ MEMORY MAP



MB90F922 / MB90922
MB90F923 / MB90F924

Parts No.	ROM (Flash) capacitance	RAM capacitance	Address #1	Address #2	Address #3
MB90F922NC/F922NCS/922NCS	256 Kbytes	10 Kbytes	FC0000H	004000H	002900H
MB90F923NC/F923NCS	384 Kbytes	16 Kbytes	FA0000H	004A00H	003700H
MB90F924NC/F924NCS	512 Kbytes	24 Kbytes	F80000H	006A00H	003700H

* : Evaluation products do not contain internal ROM. Treat this address as the ROM decode area used by the tools.

Note: To select models without the ROM mirror function, refer to the “ROM Mirror Function Selection Module” in Hardware Manual. The image of the ROM data in the FF bank appears at the top of the 00 bank, in order to enable efficient use of small C compiler models. The lower 16-bits of the FF bank addresses are allocated to the same addresses as the lower 16-bits of the 00 bank, making it possible to reference tables in ROM without declaring the “far” modifier with the pointers. For example, when an access is made to the address 00C000H, the actual address to be accessed is FFC000H in ROM. Because the size of the FF bank ROM area exceeds 32 Kbytes, it is not possible to view the entire region in the 00 bank image. Therefore because the ROM data from FF8000H to FFFFFFH appears in the image from 008000H to 00FFFFH, it is recommended that ROM data tables be stored in the area from FF8000H to FFFFFFH.

Address	Register name	Symbol	Read/write	Resource name	Initial value
003944H	Input capture register 6	IPCP6	R	Input capture 6/7	XXXXXXXXB
003945H					XXXXXXXXB
003946H	Input capture register 7	IPCP7	R		XXXXXXXXB
003947H					XXXXXXXXB
003948H to 00394FH	(Disabled)				
003950H	Minute data register 2/Reload register 2	TMR2/ TMRLR2	R/W	16-bit reload timer 2	XXXXXXXXB
003951H					XXXXXXXXB
003952H	Minute data register 3/Reload register 3	TMR3/ TMRLR3	R/W	16-bit reload timer 3	XXXXXXXXB
003953H					XXXXXXXXB
003954H to 003957H	(Disabled)				
003958H	Sub second data register	WTBR	R/W	Real time watch timer	XXXXXXXXB
003959H					XXXXXXXXB
00395AH					XXXXXXXXB
00395BH	Second data register	WTSR	R/W		XX000000B
00395CH	Minute data register	WTMR	R/W		XX000000B
00395DH	Hour data register	WTHR	R/W		XXX00000B
00395EH	Day data register	WTDR	R/W		00X00001B
00395FH	(Disabled)				
003960H	LCD display RAM	VRAM	R/W	LCD controller/ driver	XXXXXXXXB
003961H					XXXXXXXXB
003962H					XXXXXXXXB
003963H					XXXXXXXXB
003964H					XXXXXXXXB
003965H					XXXXXXXXB
003966H					XXXXXXXXB
003967H					XXXXXXXXB
003968H					XXXXXXXXB
003969H					XXXXXXXXB
00396AH					XXXXXXXXB
00396BH					XXXXXXXXB
00396CH					XXXXXXXXB
00396DH					XXXXXXXXB
00396EH					XXXXXXXXB
00396FH					XXXXXXXXB

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
003970H to 003973H	(Disabled)				
003974H	Frequency data register 1	SGFR1	R/W	Sound generator 1	XXXXXXXXB
003975H	Amplitude data register 1	SGAR1	R/W		00000000B
003976H	Decrement grade register 1	SGDR1	R/W		XXXXXXXXB
003977H	Tone count register 1	SGTR1	R/W		XXXXXXXXB
003978H to 00397FH	(Disabled)				
003980H	PWM1 compare register 0	PWC10	R/W	Stepping motor controller 0	XXXXXXXXB
003981H					XXXXXXXXB
003982H	PWM2 compare register 0	PWC20	R/W		XXXXXXXXB
003983H					XXXXXXXXB
003984H	PWM1 select register 0	PWS10	R/W		00000000B
003985H	PWM2 select register 0	PWS20	R/W		X0000000B
003986H, 003987H	(Disabled)				
003988H	PWM1 compare register 1	PWC11	R/W	Stepping motor controller 1	XXXXXXXXB
003989H					XXXXXXXXB
00398AH	PWM2 compare register 1	PWC21	R/W		XXXXXXXXB
00398BH					XXXXXXXXB
00398CH	PWM1 select register 1	PWS11	R/W		00000000B
00398DH	PWM2 select register 1	PWS21	R/W		X0000000B
00398EH, 00398FH	(Disabled)				
003990H	PWM1 compare register 2	PWC12	R/W	Stepping motor controller 2	XXXXXXXXB
003991H					XXXXXXXXB
003992H	PWM2 compare register 2	PWC22	R/W		XXXXXXXXB
003993H					XXXXXXXXB
003994H	PWM1 select register 2	PWS12	R/W		00000000B
003995H	PWM2 select register 2	PWS22	R/W		X0000000B
003996H, 003997H	(Disabled)				

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Address	Register name	Symbol	Read/write	Resource name	Initial value
003998H	PWM1 compare register 3	PWC13	R/W	Stepping motor controller 3	XXXXXXXXB
003999H					XXXXXXXXB
00399AH	PWM2 compare register 3	PWC23	R/W		XXXXXXXXB
00399BH					XXXXXXXXB
00399CH	PWM1 select register 3	PWS13	R/W		00000000B
00399DH	PWM2 select register 3	PWS23	R/W		X0000000B
00399EH to 0039A5H	(Disabled)				
0039A6H	Flash write control register 0	FWR0	R/W	Flash I/F	00000000B
0039A7H	Flash write control register 1	FWR1			00000000B
0039A8H to 0039BFH	(Disabled)				
0039C0H to 0039DFH	Area reserved for CAN Controller 2. Refer to “■ CAN CONTROLLERS”				
0039E0H to 0039FFH	Area reserved for CAN Controller 3. Refer to “■ CAN CONTROLLERS”				
003A00H to 003AFFH	Area reserved for CAN Controller 0. Refer to “■ CAN CONTROLLERS”				
003B00H to 003BFFH	Area reserved for CAN Controller 1. Refer to “■ CAN CONTROLLERS”				
003C00H to 003CFFH	Area reserved for CAN Controller 0. Refer to “■ CAN CONTROLLERS”				
003D00H to 003DFFH	Area reserved for CAN Controller 1. Refer to “■ CAN CONTROLLERS”				
003E00H to 003EFFH	Area reserved for CAN Controller 2. Refer to “■ CAN CONTROLLERS”				
003F00H to 003FFFH	Area reserved for CAN Controller 3. Refer to “■ CAN CONTROLLERS”				

■ CAN CONTROLLERS

The CAN controller has the following features :

- Conforms to CAN Specification Version 2.0 Part A and B
  - Supports transmission/reception in standard frame and extended frame formats
- Supports transmission of data frames by receiving remote frames
- 16 transmission/reception message buffers
  - 29-bit ID and 8-byte data
  - Multi-level message buffer configuration
- Provides full-bit comparison, full-bit mask, acceptance register 0/acceptance register 1 for each message buffer as ID acceptance mask
  - 2 acceptance mask registers in either standard frame format or extended frame formats
- Bit rate programmable from 10 kbps to 2 Mbps (when input clock is at 16 MHz)

List of Control Registers(1)

Address				Register	Abbreviation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003C00H	003D00H	003E00H	003F00H	Control status register	CSR	R/W, R	00---000B 0----0-1B
003C01H	003D01H	003E01H	003F01H				
003C02H	003D02H	003E02H	003F02H	Last event indicator register	LEIR	R/W	--------B 000-0000B
003C03H	003D03H	003E03H	003F03H				
003C04H	003D04H	003E04H	003F04H	RX/TX error counter	RTEC	R	00000000B 00000000B
003C05H	003D05H	003E05H	003F05H				
003C06H	003D06H	003E06H	003F06H	Bit timing register	BTR	R/W	-1111111B 11111111B
003C07H	003D07H	003E07H	003F07H				

(Continued)

Address				Register	Abbre-viation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003A40H	003B40H	003740H	003840H	ID register 8	IDR8	R/W	XXXXXXXXB XXXXXXXXB
003A41H	003B41H	003741H	003841H				
003A42H	003B42H	003742H	003842H				XXXXX---B XXXXXXXXB
003A43H	003B43H	003743H	003843H				
003A44H	003B44H	003744H	003844H	ID register 9	IDR9	R/W	XXXXXXXXB XXXXXXXXB
003A45H	003B45H	003745H	003845H				
003A46H	003B46H	003746H	003846H				XXXXX---B XXXXXXXXB
003A47H	003B47H	003747H	003847H				
003A48H	003B48H	003748H	003848H	ID register 10	IDR10	R/W	XXXXXXXXB XXXXXXXXB
003A49H	003B49H	003749H	003849H				
003A4AH	003B4AH	00374AH	00384AH				XXXXX---B XXXXXXXXB
003A4BH	003B4BH	00374BH	00384BH				
003A4CH	003B4CH	00374CH	00384CH	ID register 11	IDR11	R/W	XXXXXXXXB XXXXXXXXB
003A4DH	003B4DH	00374DH	00384DH				
003A4EH	003B4EH	00374EH	00384EH				XXXXX---B XXXXXXXXB
003A4FH	003B4FH	00374FH	00384FH				
003A50H	003B50H	003750H	003850H	ID register 12	IDR12	R/W	XXXXXXXXB XXXXXXXXB
003A51H	003B51H	003751H	003851H				
003A52H	003B52H	003752H	003852H				XXXXX---B XXXXXXXXB
003A53H	003B53H	003753H	003853H				
003A54H	003B54H	003754H	003854H	ID register 13	IDR13	R/W	XXXXXXXXB XXXXXXXXB
003A55H	003B55H	003755H	003855H				
003A56H	003B56H	003756H	003856H				XXXXX---B XXXXXXXXB
003A57H	003B57H	003757H	003857H				
003A58H	003B58H	003758H	003858H	ID register 14	IDR14	R/W	XXXXXXXXB XXXXXXXXB
003A59H	003B59H	003759H	003859H				
003A5AH	003B5AH	00375AH	00385AH				XXXXX---B XXXXXXXXB
003A5BH	003B5BH	00375BH	00385BH				
003A5CH	003B5CH	00375CH	00385CH	ID register 15	IDR15	R/W	XXXXXXXXB XXXXXXXXB
003A5DH	003B5DH	00375DH	00385DH				
003A5EH	003B5EH	00375EH	00385EH				XXXXX---B XXXXXXXXB
003A5FH	003B5FH	00375FH	00385FH				

List of Message Buffers (DLC Registers)

Address				Register	Abbreviation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003A60H	003B60H	003760H	003860H	DLC register 0	DLCR0	R/W	----XXXXB
003A61H	003B61H	003761H	003861H				
003A62H	003B62H	003762H	003862H	DLC register 1	DLCR1	R/W	----XXXXB
003A63H	003B63H	003763H	003863H				
003A64H	003B64H	003764H	003864H	DLC register 2	DLCR2	R/W	----XXXXB
003A65H	003B65H	003765H	003865H				
003A66H	003B66H	003766H	003866H	DLC register 3	DLCR3	R/W	----XXXXB
003A67H	003B67H	003767H	003867H				
003A68H	003B68H	003768H	003868H	DLC register 4	DLCR4	R/W	----XXXXB
003A69H	003B69H	003769H	003869H				
003A6AH	003B6AH	00376AH	00386AH	DLC register 5	DLCR5	R/W	----XXXXB
003A6BH	003B6BH	00376BH	00386BH				
003A6CH	003B6CH	00376CH	00386CH	DLC register 6	DLCR6	R/W	----XXXXB
003A6DH	003B6DH	00376DH	00386DH				
003A6EH	003B6EH	00376EH	00386EH	DLC register 7	DLCR7	R/W	----XXXXB
003A6FH	003B6FH	00376FH	00386FH				
003A70H	003B70H	003770H	003870H	DLC register 8	DLCR8	R/W	----XXXXB
003A71H	003B71H	003771H	003871H				
003A72H	003B72H	003772H	003872H	DLC register 9	DLCR9	R/W	----XXXXB
003A73H	003B73H	003773H	003873H				
003A74H	003B74H	003774H	003874H	DLC register 10	DLCR10	R/W	----XXXXB
003A75H	003B75H	003775H	003875H				
003A76H	003B76H	003776H	003876H	DLC register 11	DLCR11	R/W	----XXXXB
003A77H	003B77H	003777H	003877H				
003A78H	003B78H	003778H	003878H	DLC register 12	DLCR12	R/W	----XXXXB
003A79H	003B79H	003779H	003879H				
003A7AH	003B7AH	00377AH	00387AH	DLC register 13	DLCR13	R/W	----XXXXB
003A7BH	003B7BH	00377BH	00387BH				
003A7CH	003B7CH	00377CH	00387CH	DLC register 14	DLCR14	R/W	----XXXXB
003A7DH	003B7DH	00377DH	00387DH				
003A7EH	003B7EH	00377EH	00387EH	DLC register 15	DLCR15	R/W	----XXXXB
003A7FH	003B7FH	00377FH	00387FH				

■ INTERRUPT SOURCES, INTERRUPT VECTORS, AND INTERRUPT CONTROL REGISTERS

Interrupt source	EI²OS corresponding	Interrupt vector			Interrupt control register		Priority *2
		Number		Address	ICR	Address	
Reset	×	#08	08H	FFFFDCH	—	—	High
INT9 instruction	×	#09	09H	FFFFD8H	—	—	
Exception processing	×	#10	0AH	FFFFD4H	—	—	
CAN0 received/CAN2 received	×	#11	0BH	FFFFD0H	ICR00	0000B0H*1	
CAN0 transmitted/node status/ CAN2 transmitted/node status	×	#12	0CH	FFFFCCH			
CAN1 received/CAN3 received	×	#13	0DH	FFFFC8H	ICR01	0000B1H*1	
CAN1 transmitted/node status/ CAN3 transmitted/node status/SIO	×	#14	0EH	FFFFC4H			
Input capture 0	△	#15	0FH	FFFFC0H	ICR02	0000B2H*1	
DTP/ external interrupt - ch.0/ch.1 detected	△	#16	10H	FFFFBCH			
Reload timer 0	△	#17	11H	FFFFB8H	ICR03	0000B3H*1	
Reload timer 2	△	#18	12H	FFFFB4H			
Input capture 1	△	#19	13H	FFFFB0H	ICR04	0000B4H*1	
DTP/ external interrupt - ch.2/ch.3 detected	△	#20	14H	FFFFACH			
Input capture 2	△	#21	15H	FFFFA8H	ICR05	0000B5H*1	
Reload timer 3	△	#22	16H	FFFFA4H			
Input capture 3/4/5/6/7	△	#23	17H	FFFFA0H	ICR06	0000B6H*1	
DTP/ external interrupt - ch.4/ ch.5 detected UART3 RX	△	#24	18H	FFFF9CH			
PPG timer 0	△	#25	19H	FFFF98H	ICR07	0000B7H*1	
DTP/ external interrupt - ch.6/ ch.7 detected UART3 TX	△	#26	1AH	FFFF94H			
PPG timer 1	△	#27	1BH	FFFF90H	ICR08	0000B8H*1	
Reload timer 1	△	#28	1CH	FFFF8CH			
PPG timer 2/3/4/5	○	#29	1DH	FFFF88H	ICR09	0000B9H*1	
Real time watch timer watch timer (sub clock)	×	#30	1EH	FFFF84H			
Free-run timer overflow/clear	×	#31	1FH	FFFF80H	ICR10	0000BAH *1	
A/D converter conversion complete	○	#32	20H	FFFF7CH			
Sound generator 0/1	×	#33	21H	FFFF78H	ICR11	0000BBH*1	
Time-base timer	×	#34	22H	FFFF74H			
UART2 RX	○	#35	23H	FFFF70H	ICR12	0000BCH*1	
UART2 TX	△	#36	24H	FFFF6CH			Low

(Continued)

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	
	AV_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	$AV_{CC} = V_{CC}$*2
	AVRH	V_{SS} – 0.3	V_{SS} + 6.0	V	$AV_{CC} \geq$ AVRH*2
	DV_{CC}	V_{SS} – 0.3	V_{SS} + 6.0	V	$DV_{CC} = V_{CC}$*2
Input voltage*1	V_I	V_{SS} – 0.3	V_{CC} + 0.3	V	*3
Output voltage*1	V_O	V_{SS} – 0.3	V_{CC} + 0.3	V	
Maximum clamp current	I_{CLAMP}	– 4	+ 4	mA	*7
Total maximum clamp current	$\Sigma \lvert I_{CLAMP} \rvert$	—	40	mA	*7
"L" level maximum output current*4	I_{OL1}	—	15	mA	Except P70 to P77 and P80 to P87
	I_{OL2}	—	40	mA	P70 to P77 and P80 to P87
"L" level average output current*5	I_{OLAV1}	—	4	mA	Except P70 to P77 and P80 to P87
	I_{OLAV2}	—	30	mA	P70 to P77 and P80 to P87
"L" level maximum total output current	ΣI_{OL1}	—	100	mA	Except P70 to P77 and P80 to P87
	ΣI_{OL2}	—	330	mA	P70 to P77 and P80 to P87
"L" level average total output current	ΣI_{OLAV1}	—	50	mA	Except P70 to P77 and P80 to P87
	ΣI_{OLAV2}	—	250	mA	P70 to P77 and P80 to P87
"H" level maximum output current	I_{OH1}*4	—	–15	mA	Except P70 to P77 and P80 to P87
	I_{OH2}*4	—	–40	mA	P70 to P77 and P80 to P87
"H" level average output current	I_{OHAV1}*5	—	–4	mA	Except P70 to P77 and P80 to P87
	I_{OHAV2}*5	—	–30	mA	P70 to P77 and P80 to P87
"H" level maximum total output current	ΣI_{OH1}	—	–100	mA	Except P70 to P77 and P80 to P87
	ΣI_{OH2}	—	–330	mA	P70 to P77 and P80 to P87
"H" level average total output current	ΣI_{OHAV1}*6	—	–50	mA	Except P70 to P77 and P80 to P87
	ΣI_{OHAV2}*6	—	–250	mA	P70 to P77 and P80 to P87
Power consumption	P_D	—	625	mW	
Operating temperature	T_A	– 40	+ 105	°C	
Storage temperature	T_{STG}	– 55	+ 150	°C	

*1 : The parameter is based on $V_{SS} = AV_{SS} = DV_{SS} = 0.0$ V.

*2 : AV_{CC}, AVRH must not exceed V_{CC}, and AVRH must not exceed AV_{CC}.
When using an evaluation product, DV_{CC} must not exceed V_{CC} (however, DV_{CC} can be set to a higher voltage than V_{CC} when using a Flash memory product).

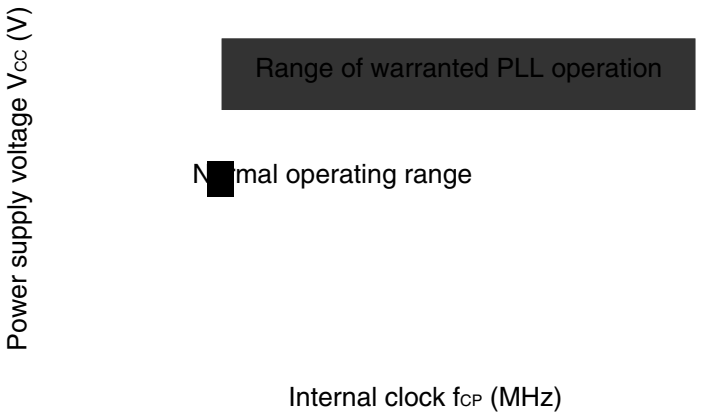
*3 : If the input current or the maximum input current is limited using external components, I_{CLAMP} is the applicable rating instead of V_I.

*4 : Maximum output current is defined as the peak value of current through any one of the corresponding pins.

(Continued)

• **Guaranteed PLL Operation Range**

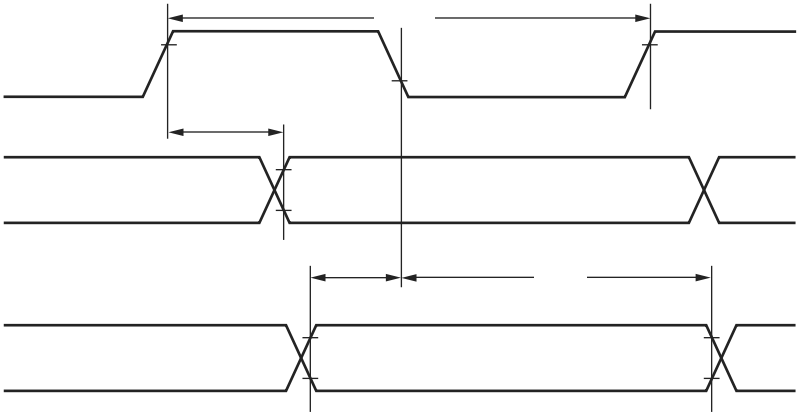
Internal operating clock frequency vs. Power supply voltage



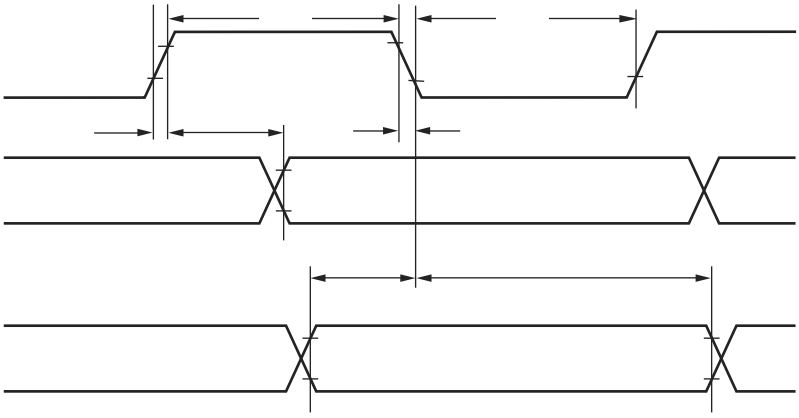
Notes : • For PLL 1 × only, use with tcp = 4 MHz or greater.
• Refer to “5. A/D Converter (1) Electrical Characteristics” for details on the A/D converter operating frequency.

(Continued)

- Internal shift clock mode



- External shift clock mode

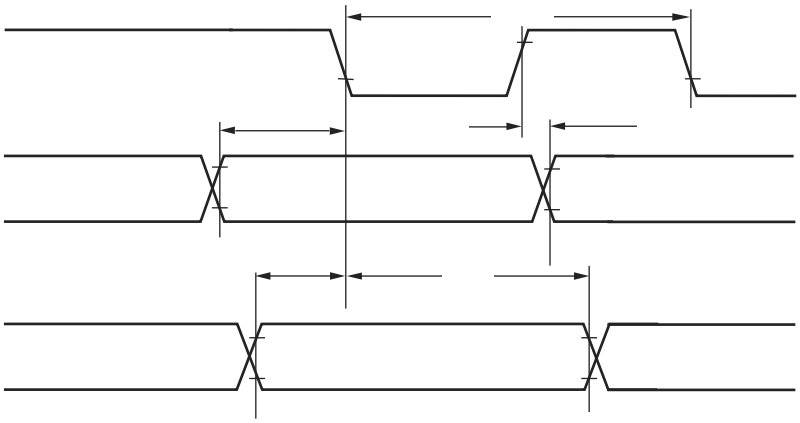


• **Bit setting: ESCR0/1/2/3:SCES=0, ECCR0/1/2/3:SCDE=1**

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode output pin C_L = 80 pF + 1TTL	5 t_{CP}	—	ns
SCK ↑ → SOT delay time	t_{SHOVI}	SCK0 to SCK3, SOT0 to SOT3		– 50	+ 50	ns
Valid SIN → SCK ↓	t_{IVSLI}	SCK0 to SCK3, SIN0 to SIN3		t_{CP} + 80	—	ns
SCK ↓ → valid SIN hold time	t_{SLIXI}			0	—	ns
SOT → SCK ↓ delay time	t_{SOVLI}	SCK0 to SCK3, SOT0 to SOT3		3 t_{CP} – 70	—	ns

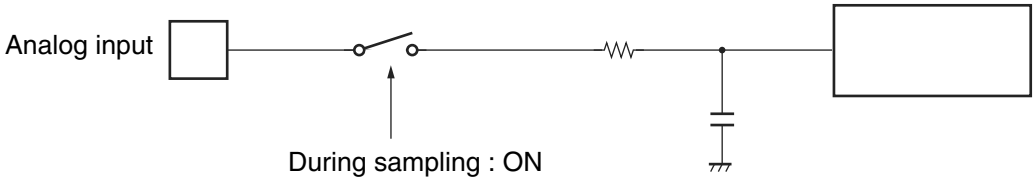
Notes : • Depending on the machine clock frequency to be used, the maximum baud rate may be limited by some parameters. These parameters are shown in “MB90920 series hardware manual”.
• C_L is the load capacitance connected to the pin during testing.
• t_{CP} is the internal operating clock cycle time. Refer to “ (1) Clock timing”.



• **Notes on the external impedance and sampling time of analog inputs**

A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. If the sampling time is still not sufficient, connect a capacitor of about 0.1 μF to the analog input pin.

• Analog input equivalent circuit



MB90F922NC/F922NCS/ F923NC/F923NCS/F924NC/F924NCS
MB90922NCS

	R	C
4.5 V ≤ AVcc ≤ 5.5 V :	2.6 kΩ (Max)	8.5 pF (Max)
4.0 V ≤ AVcc ≤ 4.5 V :	12.1 kΩ (Max)	8.5 pF (Max)

MB90V920-101/102

4.5 V ≤ AVcc ≤ 5.5 V :	2.0 kΩ (Max)	14.4 pF (Max)
4.0 V ≤ AVcc ≤ 4.5 V :	8.2 kΩ (Max)	14.4 pF (Max)

Note : The values are reference values.

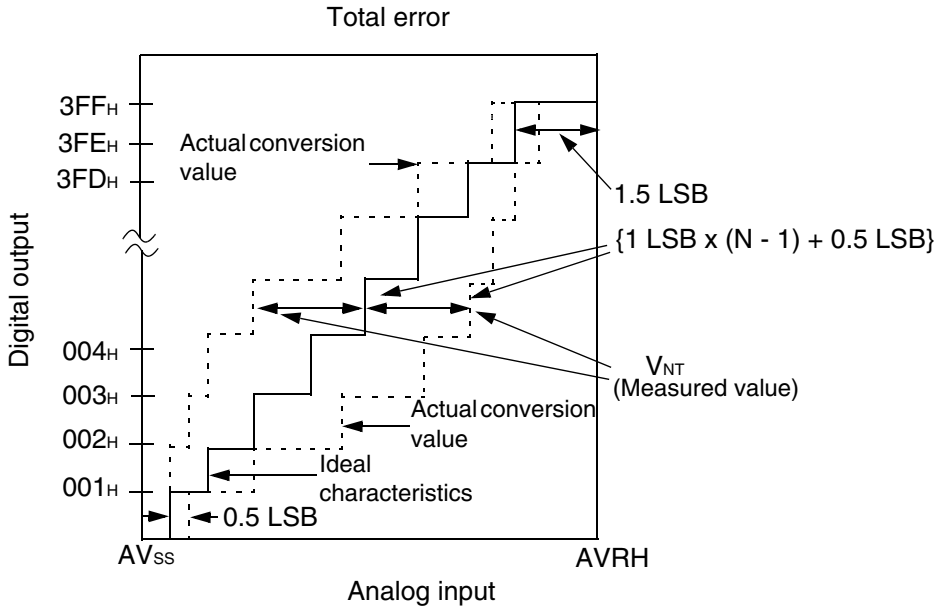
(2) Definition of terms

Resolution : Analog changes that are identifiable by the A/D converter.

Non-Linear error : The deviation of the straight line connecting the zero transition point ("00 0000 0000" ←→ "00 0000 0001") with the full-scale transition point ("11 1111 1110" ←→ "11 1111 1111") from actual conversion characteristics.

Differential linear error : The deviation from the ideal value of the input voltage needed to change the output code by 1 LSB.

Total error : The total error is the difference between the actual value and the theoretical value, and includes zero-transition error/full-scale transition error and linear error.



$$\text{Total error for digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + 0.5\ \text{LSB}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$1\ \text{LSB (Ideal)} = \frac{\text{AVRH} - \text{AV}_{SS}}{1024}\ [\text{V}]$$

N : A/D converter digital output value

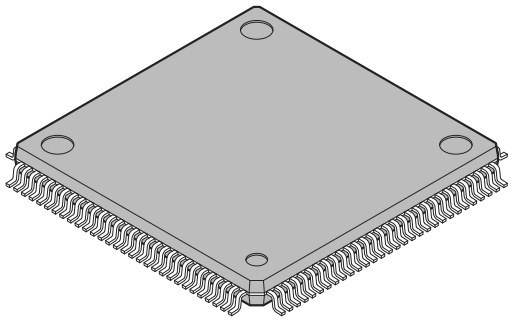
V_{OT} (Ideal) = AVss + 0.5 LSB [V]

V_{FST} (Ideal) = AVRH − 1.5 LSB [V]

V_{NT} : Voltage when the digital output changes from (N - 1) to N

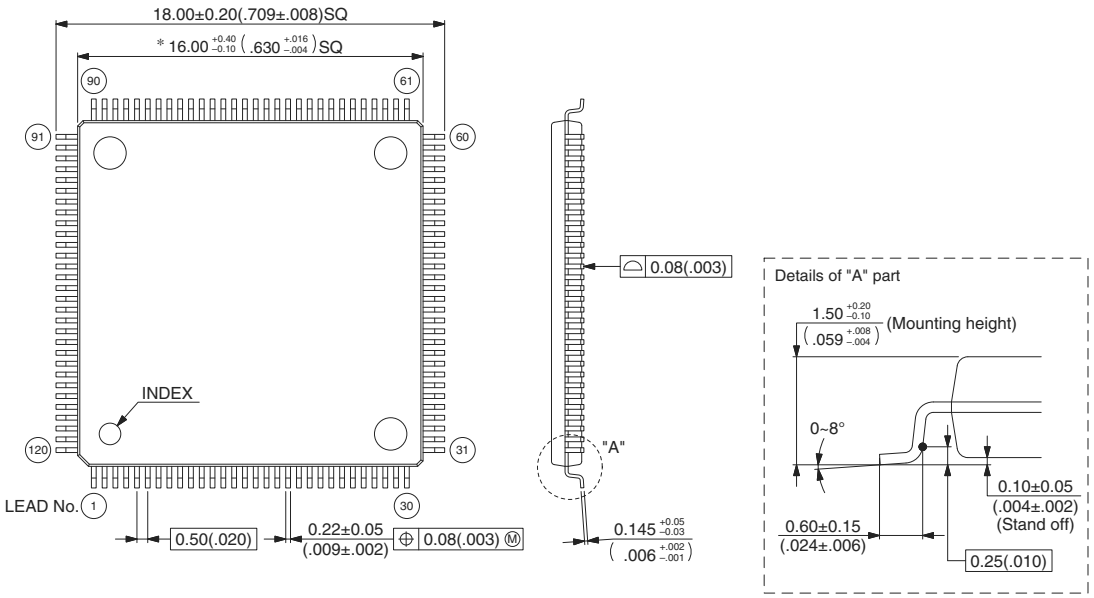
(Continued)

■ PACKAGE DIMENSION

120-pin plastic LQFP		
	Lead pitch	0.50 mm
	Package width × package length	16.0 × 16.0 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.70 mm MAX
	Weight	0.88 g
(FPT-120P-M21)	Code (Reference)	P-LFQFP120-16×16-0.50

120-pin plastic LQFP
(FPT-120P-M21)

Note 1) * : These dimensions do not include resin protrusion.
Resin protrusion is +0.25(.010) MAX(each side).
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.



Dimensions in mm (inches).
Note: The values in parentheses are reference values.

Please check the latest package dimension at the following URL.
http://edevice.fujitsu.com/package/en-search/

FUJITSU SEMICONDUCTOR LIMITED

Nomura Fudosan Shin-yokohama Bldg. 10-23, Shin-yokohama 2-Chome,
Kohoku-ku Yokohama Kanagawa 222-0033, Japan
Tel: +81-45-415-5858
http://jp.fujitsu.com/fsl/en/

For further information please contact:

North and South America
FUJITSU SEMICONDUCTOR AMERICA, INC.
1250 E. Arques Avenue, M/S 333
Sunnyvale, CA 94085-5401, U.S.A.
Tel: +1-408-737-5600 Fax: +1-408-737-5999
http://us.fujitsu.com/micro/

Europe
FUJITSU SEMICONDUCTOR EUROPE GmbH
Pittlerstrasse 47, 63225 Langen, Germany
Tel: +49-6103-690-0 Fax: +49-6103-690-122
http://emea.fujitsu.com/semiconductor/

Korea
FUJITSU SEMICONDUCTOR KOREA LTD.
206 Kosmo Tower Building, 1002 Daechi-Dong,
Gangnam-Gu, Seoul 135-280, Republic of Korea
Tel: +82-2-3484-7100 Fax: +82-2-3484-7111
http://kr.fujitsu.com/fmk/

Asia Pacific
FUJITSU SEMICONDUCTOR ASIA PTE. LTD.
151 Lorong Chuan,
#05-08 New Tech Park 556741 Singapore
Tel : +65-6281-0770 Fax : +65-6281-0220
http://www.fujitsu.com/sg/services/micro/semiconductor/

FUJITSU SEMICONDUCTOR SHANGHAI CO., LTD.
Rm. 3102, Bund Center, No.222 Yan An Road (E),
Shanghai 200002, China
Tel : +86-21-6146-3688 Fax : +86-21-6335-1605
http://cn.fujitsu.com/fss/

FUJITSU SEMICONDUCTOR PACIFIC ASIA LTD.
10/F., World Commerce Centre, 11 Canton Road,
Tsimshatsui, Kowloon, Hong Kong
Tel : +852-2377-0226 Fax : +852-2376-3269
http://cn.fujitsu.com/fsp/

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